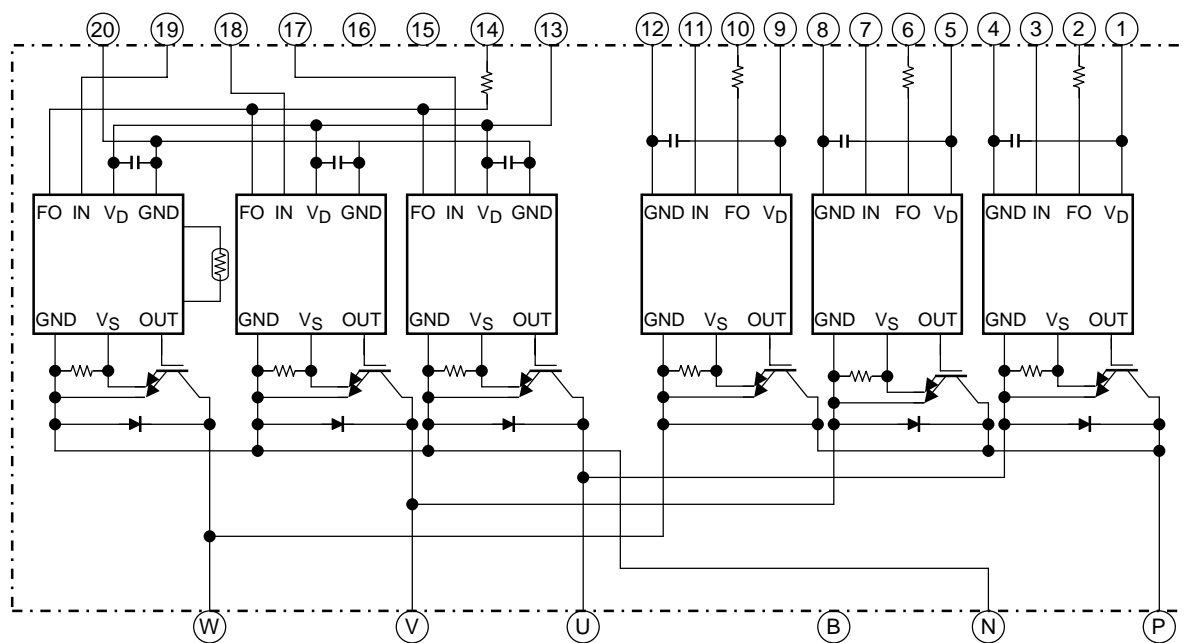


# MIG50Q6CSB1X (1200V/50A 6in1)

High Power Switching Applications  
 Motor Control Applications

- Integrates inverter and control circuits (IGBT drive units, protection units for short-circuit current, over current, under voltage and over temperature) in one package.
- The electrodes are isolated from case.
- $V_{CE(sat)} = 2.2\text{ V (typ.)}$
- UL recognized: File No. E87989

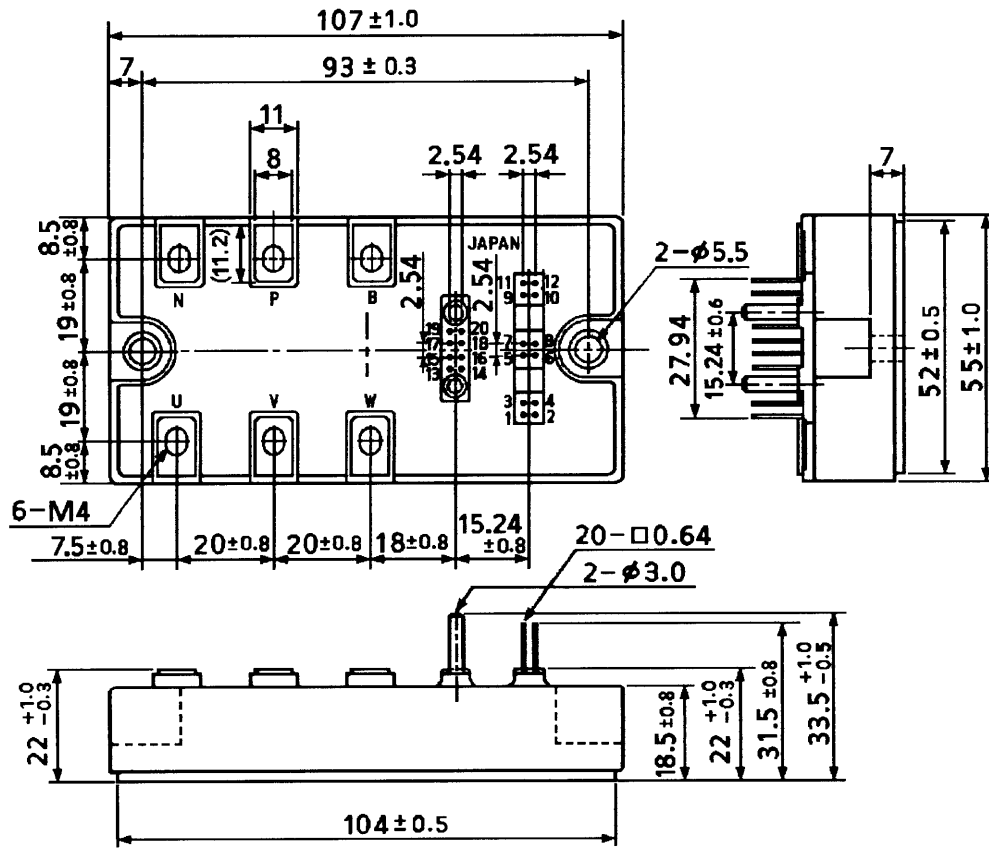
## Equivalent Circuit



1. $V_D$ (U)	2. FO (U)	3. IN (U)	4. GND (U)	5. $V_D$ (V)	6. FO (V)	7. IN (V)
8. GND (V)	9. $V_D$ (W)	10. FO (W)	11. IN (W)	12. GND (W)	13. $V_D$ (L)	14. FO (L)
15. Open	16. Open	17. IN (X)	18. IN (Y)	19. IN (Z)	20. GND (L)	

## Package Dimensions: TOSHIBA 2-108G1D

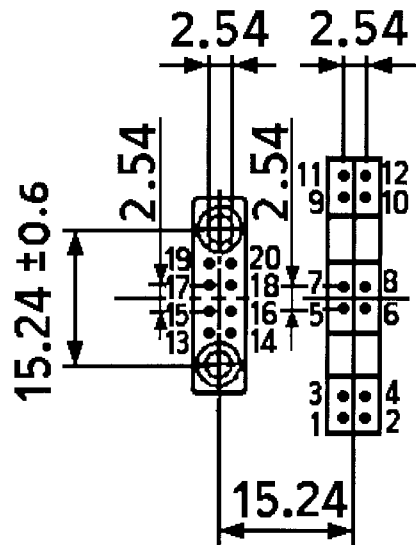
Unit: mm



- |               |             |              |            |              |             |
|---------------|-------------|--------------|------------|--------------|-------------|
| 1. $V_D$ (U)  | 2. FO (U)   | 3. IN (U)    | 4. GND (U) | 5. $V_D$ (V) | 6. FO (V)   |
| 7. IN (V)     | 8. GND (V)  | 9. $V_D$ (W) | 10. FO (W) | 11. IN (W)   | 12. GND (W) |
| 13. $V_D$ (L) | 14. FO (L)  | 15. Open     | 16. Open   | 17. IN (X)   | 18. IN (Y)  |
| 19. IN (Z)    | 20. GND (L) |              |            |              |             |

## Signal Terminal Layout

Unit: mm



1. V <sub>D</sub> (U)	2. FO (U)	3. IN (U)	4. GND (U)	5. V <sub>D</sub> (V)	6. FO (V)
7. IN (V)	8. GND (V)	9. V <sub>D</sub> (W)	10. FO (W)	11. IN (W)	12. GND (W)
13. V <sub>D</sub> (L)	14. FO (L)	15. Open	16. Open	17. IN (X)	18. IN (Y)
19. IN (Z)	20. GND (L)				

## Maximum Ratings (unless otherwise specified, $T_j = 25^\circ\text{C}$ )

Stage	Characteristic	Condition	Symbol	Ratings	Unit
Inverter	Supply voltage	P-N power terminal	$V_{CC}$	900	V
	Collector-emitter voltage	—	$V_{CES}$	1200	V
	Collector current	$T_c = 25^\circ\text{C}$ , DC	$I_C$	50	A
	Forward current	$T_c = 25^\circ\text{C}$ , DC	$I_F$	50	A
	Collector power dissipation	$T_c = 25^\circ\text{C}$	$P_C$	580	W
	Junction temperature	—	$T_j$	150	$^\circ\text{C}$
Control	Control supply voltage	$V_D$ -GND terminal	$V_D$	20	V
	Input voltage	IN-GND terminal	$V_{IN}$	20	V
	Fault output voltage	FO-GND terminal	$V_{FO}$	20	V
	Fault output current	FO sink current	$I_{FO}$	14	mA
Module	Operating temperature	—	$T_c$	-20 to 100	$^\circ\text{C}$
	Storage temperature range	—	$T_{stg}$	-40 to 125	$^\circ\text{C}$
	Isolation voltage	AC 1 minute	$V_{ISO}$	2500	V
	Screw torque (terminal)	M4	—	2	N·m
	Screw torque (mounting)	M5	—	3	N·m

## Electrical Characteristics

### 1. Inverter Stage

Characteristic	Symbol	Test Condition	Min	Typ.	Max	Unit	
Collector cut-off current	$I_{CEX}$	$V_{CE} = 1200\text{ V}$	$T_j = 25^\circ\text{C}$	—	—	1	mA
			$T_j = 125^\circ\text{C}$	—	—	10	
Collector-emitter saturation voltage	$V_{CE(sat)}$	$V_D = 15\text{ V}$ , $I_C = 50\text{ A}$ , $V_{IN} = 15\text{ V} \leftrightarrow 0\text{ V}$	$T_j = 25^\circ\text{C}$	—	2.2	2.6	V
			$T_j = 125^\circ\text{C}$	—	—	3.0	
Forward voltage	$V_F$	$I_F = 50\text{ A}$ , $T_j = 25^\circ\text{C}$	—	2.4	2.8	V	
Switching time	$t_{on}$	$V_{CC} = 600\text{ V}$ , $I_C = 50\text{ A}$ , $V_D = 15\text{ V}$ , $V_{IN} = 15\text{ V} \leftrightarrow 0\text{ V}$ , $T_j = 25^\circ\text{C}$ , Inductive load (Note 1)	—	2.0	3.0	$\mu\text{s}$	
	$t_c(on)$		—	0.3	—		
	$t_{rr}$		—	0.3	—		
	$t_{off}$		—	1.5	2.5		
	$t_c(off)$		—	0.4	—		

Note 1: Switching time test circuit and timing chart.

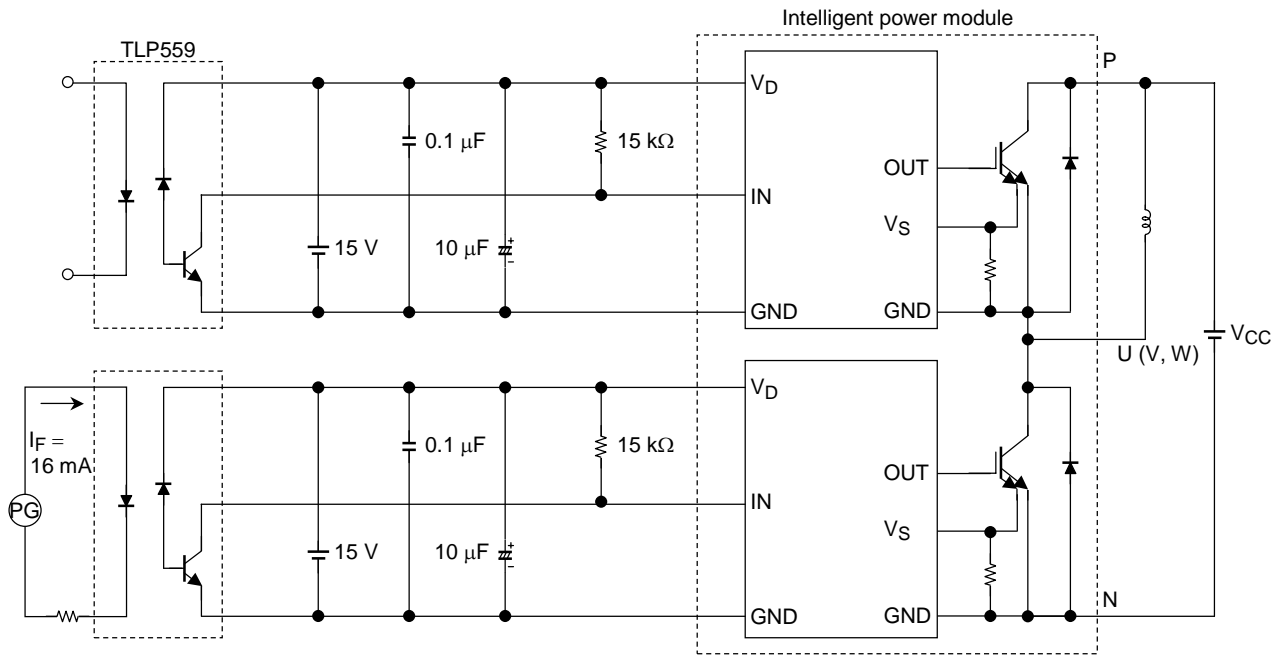
## 2. Control Stage ( $T_j = 25^\circ\text{C}$ )

Characteristic		Symbol	Test Condition	Min	Typ.	Max	Unit
Control circuit current	High side	$I_D$ (H)	$V_D = 15\text{ V}$	—	13	17	mA
	Low side	$I_D$ (L)		—	39	51	
Input-on signal voltage		$V_{IN}$ (on)	$V_D = 15\text{ V}$	1.4	1.6	1.8	V
Input-off signal voltage		$V_{IN}$ (off)	$V_D = 15\text{ V}$	2.2	2.5	2.8	V
Fault output current	Protection	$I_{FO}$ (on)	$V_D = 15\text{ V}$	8	10	12	mA
	Normal	$I_{FO}$ (off)		—	—	0.1	
Over current protection trip level	Inverter	OC	$V_D = 15\text{ V}, T_j \leq 125^\circ\text{C}$	80	—	—	A
Short-circuit current protection trip level	Inverter	SC	$V_D = 15\text{ V}, T_j \leq 125^\circ\text{C}$	80	—	—	A
Over current cut-off time		$t_{off}$ (OC)	$V_D = 15\text{ V}$	—	5	—	$\mu\text{s}$
Over temperature protection	Trip level	OT	Case temperature	110	118	125	$^\circ\text{C}$
	Reset level	OTr		—	98	—	
Control supply under voltage protection	Trip level	UV	—	11.0	12.0	12.5	V
	Reset level	UVr		12.0	12.5	13.0	
Fault output pulse width		$t_{FO}$	$V_D = 15\text{ V}$	1	2	3	ms

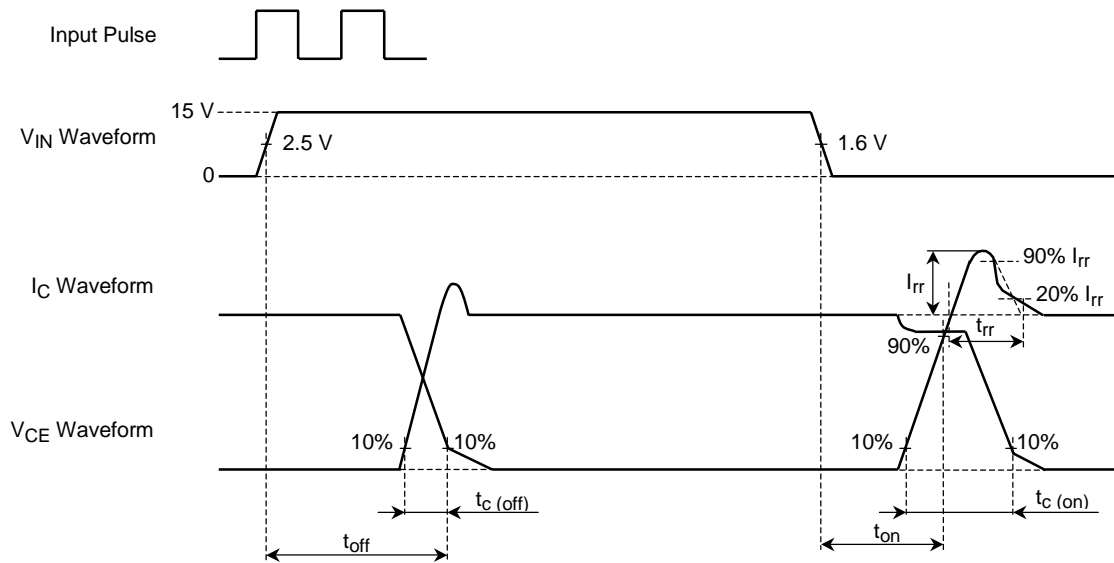
## 3. Thermal Resistance ( $T_c = 25^\circ\text{C}$ )

Characteristic	Symbol	Test Condition	Min	Typ.	Max	Unit
Junction to case thermal resistance	$R_{th}$ (j-c)	Inverter IGBT stage	—	—	0.215	$^\circ\text{C/W}$
		Inverter FRD stage	—	—	0.464	
Case to fin thermal resistance	$R_{th}$ (c-f)	Compound is applied	—	0.017	—	$^\circ\text{C/W}$

**Switching Time Test Circuit**



**Timing Chart**

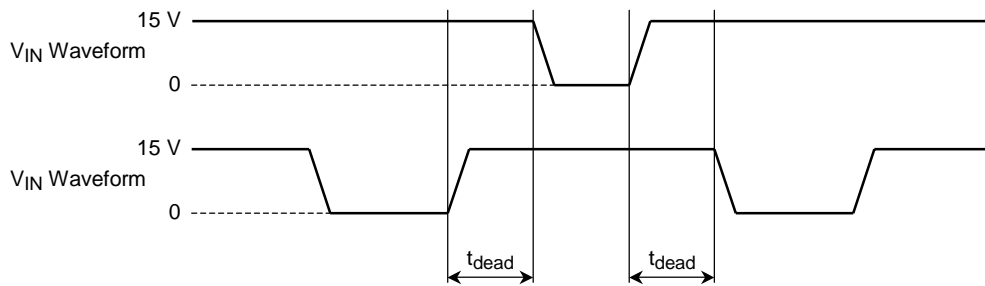


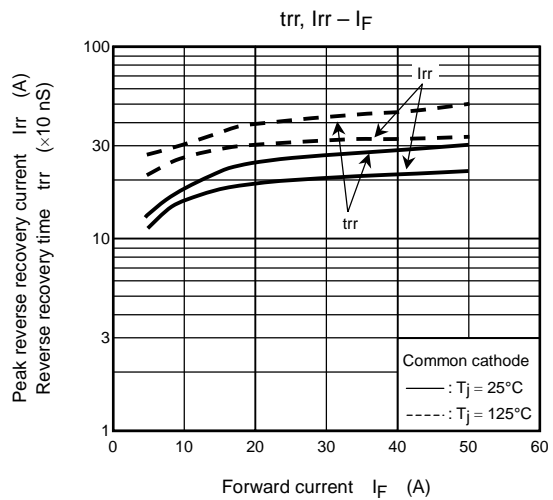
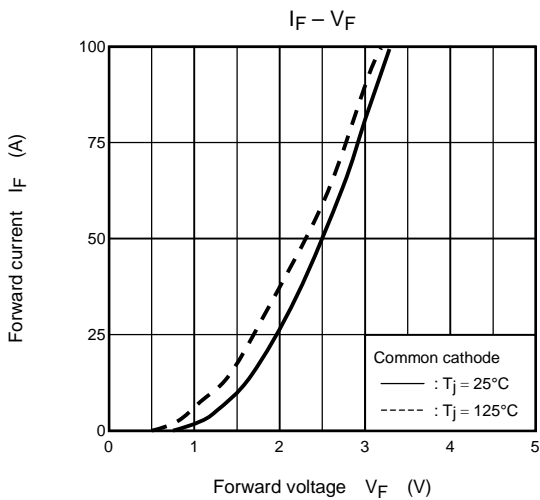
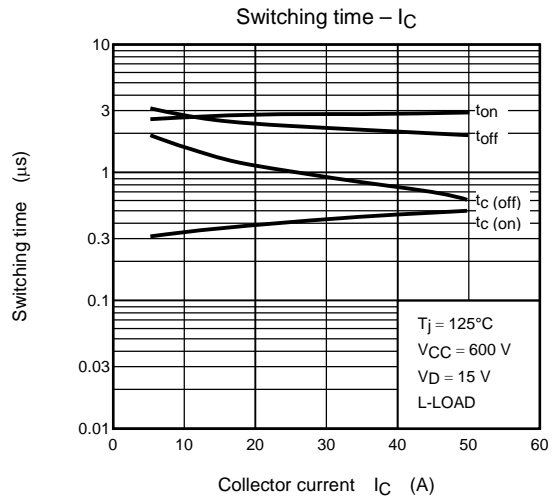
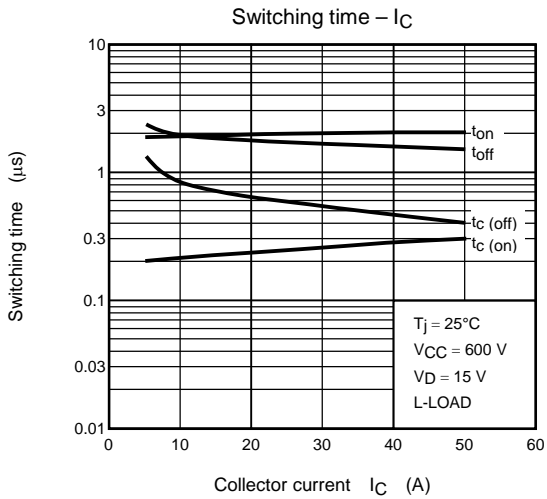
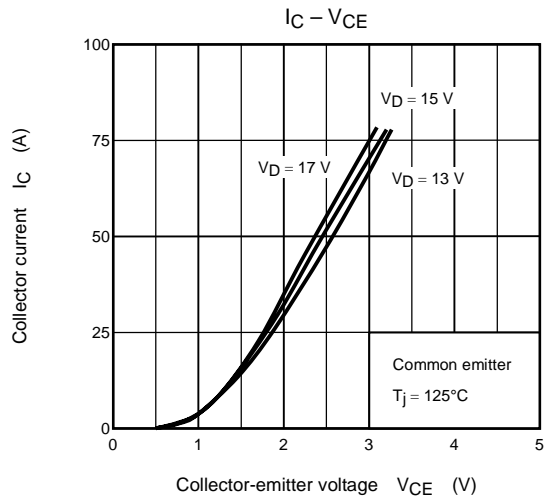
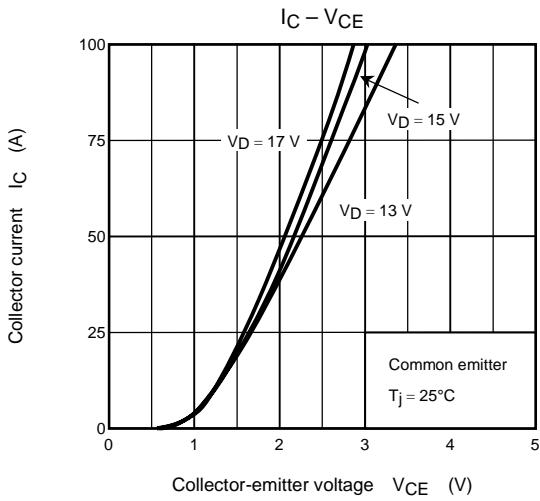
**4. Recommended conditions for application**

Characteristic	Symbol	Test Condition	Min	Typ.	Max	Unit
Supply voltage	$V_{CC}$	P-N Power terminal	—	600	800	V
Control supply voltage	$V_D$	$V_D$ -GND Signal terminal	13.5	15	16.5	V
Carrier frequency	$f_c$	PWM Control	—	—	20	kHz
Dead time	$t_{dead}$	Switching time test circuit (see page.6) (Note 2)	3	—	—	$\mu s$

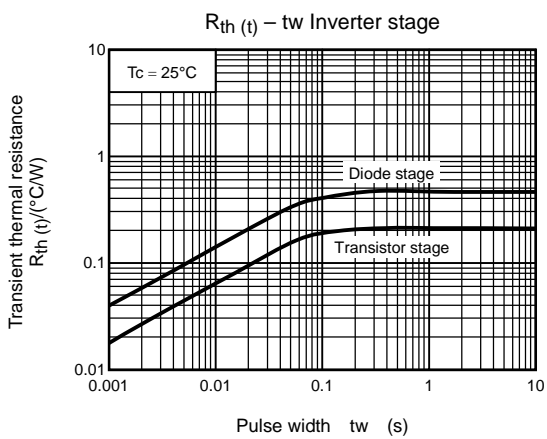
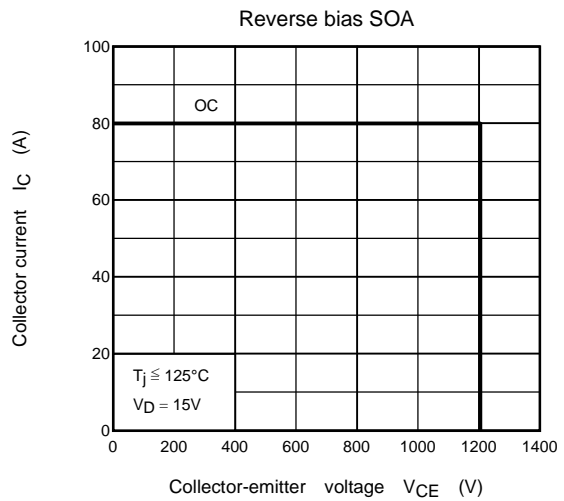
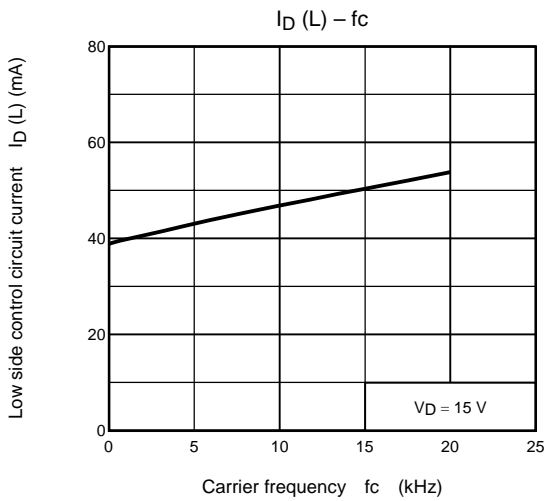
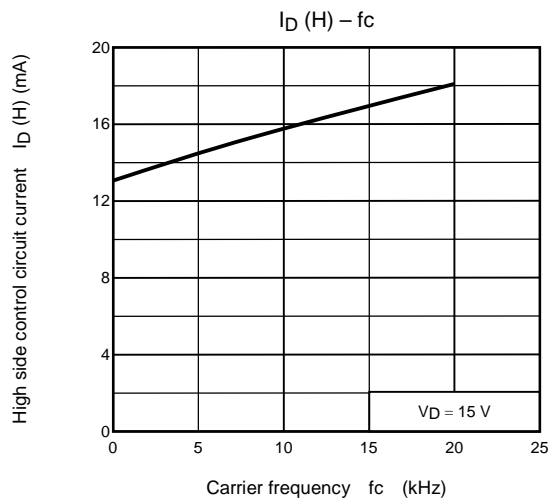
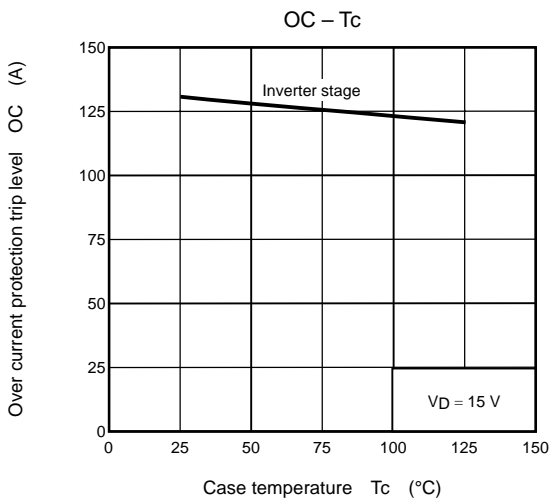
Note 2: The table lists Dead time requirements for the module input, excluding photocoupler delays. When specifying dead time requirements for the photocoupler input, please add photocoupler delays to the dead time given above.

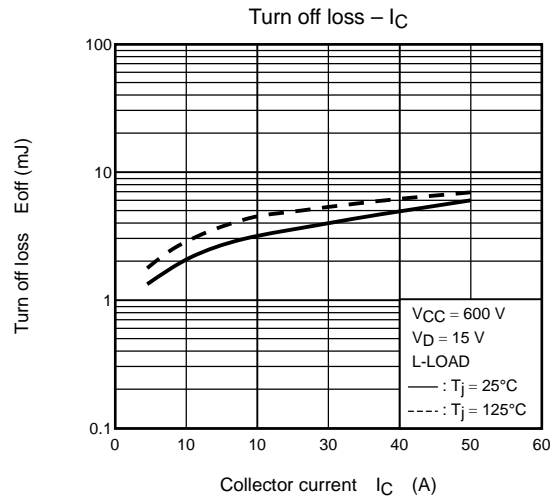
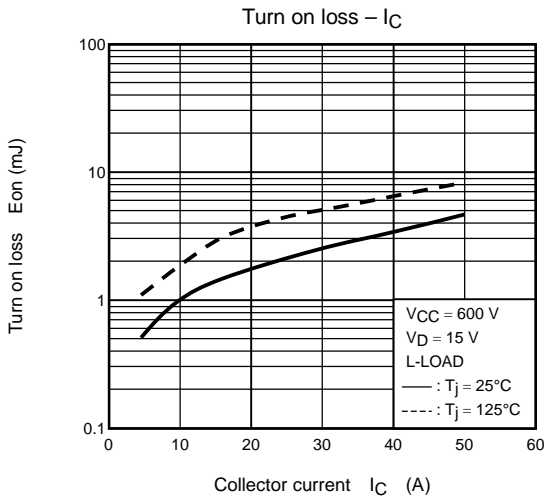
**Dead Time Timing Chart**











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